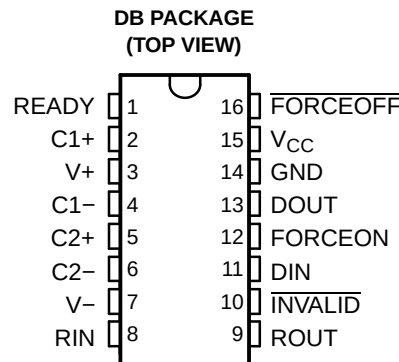


## FEATURES

- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V  $V_{CC}$  Supply
- Operates at Least 1 Mbit/s
- Low Standby Current . . . 1  $\mu$ A Typ
- External Capacitors . . .  $4 \times 0.1 \mu$ F
- Accepts 5-V Logic Input With 3.3-V Supply
- Designed to Be Interchangeable With Maxim™ MAX3227
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection for RS-232 I/O Pins
  - $\pm 15$  kV – Human-Body Model
  - $\pm 8$  kV – IEC61000-4-2, Contact Discharge
  - $\pm 8$  kV – IEC61000-4-2, Air-Gap Discharge
- Auto-Powerdown Plus Feature Automatically Disables Drivers for Power Savings
- Packaged in Plastic Shrink Small-Outline Package

## APPLICATIONS

- Battery-Powered, Hand-Held, and Portable Equipment
- PDAs and Palmtop PCs
- Notebooks, Sub-Notebooks, and Laptops
- Digital Cameras
- Mobile Phones and Wireless Devices



## DESCRIPTION/ORDERING INFORMATION

The MAX3227 consists of one line driver, one line receiver, and a dual charge-pump circuit with  $\pm 15$ -kV ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. This device operates at data-signaling rates of 1 Mbit/s in normal operating mode and a maximum of 30-V/ $\mu$ s driver output slew rate. This device also features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The MAX3227 achieves a 1- $\mu$ A supply current using the auto-powerdown plus feature. This device automatically enters a low-power powerdown mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. They turn on again when they sense a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

The MAX3227C is characterized for operation from 0°C to 70°C. The MAX3227I is characterized for operation from –40°C to 85°C.

## AVAILABLE OPTIONS

| $T_A$         | PACKAGED DEVICE                          |
|---------------|------------------------------------------|
|               | SHRINK SMALL OUTLINE (DB) <sup>(1)</sup> |
| 0°C to 70°C   | MAX3227CDB                               |
| –40°C to 85°C | MAX3227IDB                               |

- (1) The DB package is available taped and reeled. Add the suffix R to device type (e.g., MAX3227CDBR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

FUNCTION TABLE<sup>(1)</sup>

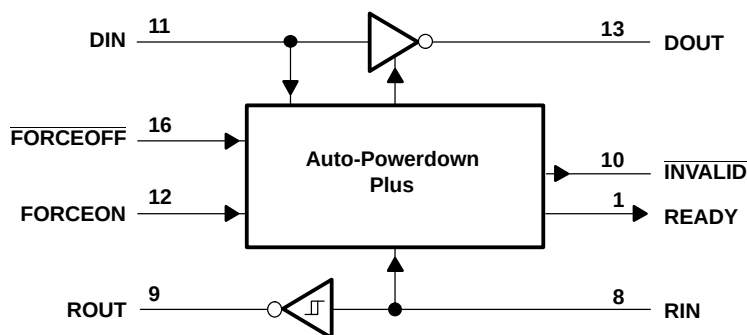
| INPUT CONDITIONS               |          |                                     |                                        | OUTPUT STATES |          |         |       | OPERATING MODE                                 |
|--------------------------------|----------|-------------------------------------|----------------------------------------|---------------|----------|---------|-------|------------------------------------------------|
| FORCEON                        | FORCEOFF | RECEIVER OR DRIVER EDGE WITHIN 30 s | VALID RS-232 LEVEL PRESENT AT RECEIVER | DRIVER        | RECEIVER | INVALID | READY |                                                |
| Auto-Powerdown Plus Conditions |          |                                     |                                        |               |          |         |       |                                                |
| H                              | H        | NO                                  | NO                                     | Active        | Active   | L       | H     | Normal operation, auto-powerdown plus disabled |
| H                              | H        | NO                                  | YES                                    | Active        | Active   | H       | H     | Normal operation, auto-powerdown plus disabled |
| L                              | H        | YES                                 | NO                                     | Active        | Active   | L       | H     | Normal operation, auto-powerdown plus enabled  |
| L                              | H        | YES                                 | YES                                    | Active        | Active   | H       | H     | Normal operation, auto-powerdown plus enabled  |
| L                              | H        | NO                                  | NO                                     | Z             | Active   | L       | L     | Powerdown, auto-powerdown plus enabled         |
| L                              | H        | NO                                  | YES                                    | Z             | Active   | H       | L     | Powerdown, auto-powerdown plus enabled         |
| X                              | L        | X                                   | NO                                     | Z             | Active   | L       | L     | Manual powerdown                               |
| X                              | L        | X                                   | YES                                    | Z             | Active   | H       | L     | Manual powerdown                               |
| Auto-Powerdown Conditions      |          |                                     |                                        |               |          |         |       |                                                |
| INVALID                        | INVALID  | X                                   | NO                                     | Z             | Active   | L       | L     | Powerdown, auto-powerdown enabled              |
| INVALID                        | INVALID  | X                                   | YES                                    | Active        | Active   | H       | H     | Normal operation, auto-powerdown enabled       |

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

### TERMINAL FUNCTIONS

| TERMINAL                     |     | DESCRIPTION                                                                                                                                             |
|------------------------------|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                         | NO. |                                                                                                                                                         |
| C1+                          | 2   | Positive terminal of voltage-doubler charge-pump capacitor                                                                                              |
| C1–                          | 4   | Negative terminal of voltage-doubler charge-pump capacitor                                                                                              |
| C2+                          | 5   | Positive terminal of inverting charge-pump capacitor                                                                                                    |
| C2–                          | 6   | Negative terminal of inverting charge-pump capacitor                                                                                                    |
| DIN                          | 11  | CMOS driver input                                                                                                                                       |
| DOUT                         | 13  | RS-232 driver output                                                                                                                                    |
| $\overline{\text{FORCEOFF}}$ | 16  | Force-off input, active low. Drive low to shut down drivers, receivers, and charge pump. This overrides auto-shutdown and FORCEON (see Function Table). |
| FORCEON                      | 12  | Force-on input, active high. Drive high to override powerdown, keeping drivers and receivers on (FORCEOFF must be high) (see Function Table).           |
| GND                          | 14  | Ground                                                                                                                                                  |
| $\overline{\text{INVALID}}$  | 10  | Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input.                              |
| READY                        | 1   | Ready to transmit output, active high. READY is enabled high when V– goes below $-3.5$ V and the device is ready to transmit.                           |
| RIN                          | 8   | RS-232 receiver input                                                                                                                                   |
| ROUT                         | 9   | CMOS receiver output                                                                                                                                    |
| V+                           | 3   | $+2 \times V_{CC}$ generated by the charge pump                                                                                                         |
| V–                           | 7   | $-2 \times V_{CC}$ generated by the charge pump                                                                                                         |
| V <sub>CC</sub>              | 15  | 3-V to 5.5-V single-supply voltage                                                                                                                      |

### LOGIC DIAGRAM (POSITIVE LOGIC)



**Absolute Maximum Ratings**<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |                                                      |                                                            | MIN       | MAX                   | UNIT |
|------------------|------------------------------------------------------|------------------------------------------------------------|-----------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range <sup>(2)</sup>                  |                                                            | −0.3      | 6                     | V    |
| V+               | Positive output supply voltage range <sup>(2)</sup>  |                                                            | −0.3      | 7                     | V    |
| V−               | Negative output supply voltage range <sup>(2)</sup>  |                                                            | 0.3       | −7                    | V    |
| V+ − V−          | Supply voltage difference <sup>(2)</sup>             |                                                            | 13        |                       | V    |
| V <sub>I</sub>   | Input voltage range                                  | Driver ( $\overline{\text{FORCEOFF}}$ , $\text{FORCEON}$ ) | −0.3      | 6                     | V    |
|                  |                                                      | Receiver                                                   | −25       | 25                    |      |
| V <sub>O</sub>   | Output voltage range                                 | Driver                                                     | −13.2     | 13.2                  | V    |
|                  |                                                      | Receiver ( $\overline{\text{INVALID}}$ , $\text{READY}$ )  | −0.3      | V <sub>CC</sub> + 0.3 |      |
|                  | Short-circuit duration                               | DOUT to GND                                                | Unlimited |                       |      |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(3)</sup>             |                                                            | 82        |                       | °C/W |
|                  | Lead temperature 1,6 mm (1/16 in) from case for 10 s |                                                            | 260       |                       | °C   |
| T <sub>stg</sub> | Storage temperature range                            |                                                            | −65       | 150                   | °C   |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network GND.

(3) The package thermal impedance is calculated in accordance with JESD 51-7.

**Recommended Operating Conditions**<sup>(1)</sup>See [Figure 5](#)

|                |                                             |                                                          | MIN                      | NOM | MAX | UNIT |
|----------------|---------------------------------------------|----------------------------------------------------------|--------------------------|-----|-----|------|
| Supply voltage |                                             | $V_{CC} = 3.3 \text{ V}$                                 | 3                        | 3.3 | 3.6 | V    |
|                |                                             | $V_{CC} = 5 \text{ V}$                                   | 4.5                      | 5   | 5.5 |      |
| $V_{IH}$       | Driver and control high-level input voltage | $\text{DIN}, \overline{\text{FORCEOFF}}, \text{FORCEON}$ | $V_{CC} = 3.3 \text{ V}$ | 2   | 5.5 | V    |
|                |                                             |                                                          | $V_{CC} = 5 \text{ V}$   | 2.4 | 5.5 |      |
| $V_{IL}$       | Driver and control low-level input voltage  | $\text{DIN}, \overline{\text{FORCEOFF}}, \text{FORCEON}$ | 0                        |     | 0.8 | V    |
| $V_I$          | Receiver input voltage                      |                                                          | –25                      |     | 25  | V    |
| $T_A$          | Operating free-air temperature              | MAX3227C                                                 | 0                        |     | 70  | °C   |
|                |                                             | MAX3227I                                                 | –40                      |     | 85  |      |

(1) Test conditions are  $C1-C4 = 0.1 \mu\text{F}$  at  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $C1 = 0.047 \mu\text{F}$ ,  $C2-C4 = 0.33 \mu\text{F}$  at  $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ .

**Electrical Characteristics**<sup>(1)</sup>over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5](#))

| PARAMETER |                                                | TEST CONDITIONS                              | MIN                                                                                                             | TYP <sup>(2)</sup> | MAX     | UNIT          |
|-----------|------------------------------------------------|----------------------------------------------|-----------------------------------------------------------------------------------------------------------------|--------------------|---------|---------------|
| $I_I$     | Input leakage current                          | $\overline{\text{FORCEOFF}}, \text{FORCEON}$ |                                                                                                                 | $\pm 0.01$         | $\pm 1$ | $\mu\text{A}$ |
| $I_{CC}$  | Supply current<br>( $T_A = 25^\circ\text{C}$ ) | Auto-powerdown plus disabled                 | No load,<br>$\overline{\text{FORCEOFF}}$ and $\text{FORCEON}$ at $V_{CC}$                                       | 0.3                | 2       | $\mu\text{A}$ |
|           |                                                | Powered off                                  | No load, $\overline{\text{FORCEOFF}}$ at GND                                                                    | 1                  | 10      |               |
|           |                                                | Auto-powerdown plus enabled                  | No load, $\overline{\text{FORCEOFF}}$ at $V_{CC}$ ,<br>$\text{FORCEON}$ at GND,<br>All RIN are open or grounded | 1                  | 10      |               |

(1) Test conditions are  $C1-C4 = 0.1 \mu\text{F}$  at  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ;  $C1 = 0.047 \mu\text{F}$ ,  $C2-C4 = 0.33 \mu\text{F}$  at  $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ .

(2) All typical values are at  $V_{CC} = 3.3 \text{ V}$  or  $V_{CC} = 5 \text{ V}$ , and  $T_A = 25^\circ\text{C}$ .

## DRIVER SECTION

### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)  
(see [Figure 1](#) and [Figure 2](#))

| PARAMETER                                                   | TEST CONDITIONS                                                                               | MIN | TYP <sup>(2)</sup> | MAX      | UNIT     |
|-------------------------------------------------------------|-----------------------------------------------------------------------------------------------|-----|--------------------|----------|----------|
| V <sub>OH</sub> High-level output voltage                   | DOUT at R <sub>L</sub> = 3 k $\Omega$ to GND, DIN = GND                                       | 5   | 5.4                |          | V        |
| V <sub>OL</sub> Low-level output voltage                    | DOUT at R <sub>L</sub> = 3 k $\Omega$ to GND, DIN = V <sub>CC</sub>                           | –5  | –5.4               |          | V        |
| I <sub>IH</sub> High-level input current                    | V <sub>I</sub> = V <sub>CC</sub>                                                              |     | $\pm 0.01$         | $\pm 1$  | $\mu$ A  |
| I <sub>IL</sub> Low-level input current                     | V <sub>I</sub> at GND                                                                         |     | $\pm 0.01$         | $\pm 1$  | $\mu$ A  |
| I <sub>OS</sub> Short-circuit output current <sup>(3)</sup> | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0 V                                                 |     | $\pm 35$           | $\pm 60$ | mA       |
|                                                             | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0 V                                                 |     | $\pm 35$           | $\pm 60$ |          |
| r <sub>o</sub> Output resistance                            | V <sub>CC</sub> , V <sub>+</sub> , and V <sub>–</sub> = 0 V, V <sub>O</sub> = $\pm 2$ V       | 300 | 10M                |          | $\Omega$ |
| I <sub>off</sub> Output leakage current                     | $\overline{\text{FORCEOFF}}$ = GND, V <sub>O</sub> = $\pm 12$ V, V <sub>CC</sub> = 0 to 5.5 V |     |                    | $\pm 25$ | $\mu$ A  |

(1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.

(2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(3) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)  
(see [Figure 1](#) and [Figure 2](#))

| PARAMETER                                    | TEST CONDITIONS                                                                                                                              | MIN  | TYP <sup>(2)</sup> | MAX | UNIT       |
|----------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|------|--------------------|-----|------------|
| Maximum data rate                            | C <sub>L</sub> = 1000 pF, R <sub>L</sub> = 3 k $\Omega$ ,<br>One DIN switching, See <a href="#">Figure 1</a>                                 | 250  |                    |     | kbit/s     |
|                                              | C <sub>L</sub> = 1000 pF, R <sub>L</sub> = 3 k $\Omega$ ,<br>V <sub>CC</sub> = 4.5 V, See <a href="#">Figure 1</a> One DIN switching,        | 1000 |                    |     |            |
|                                              | C <sub>L</sub> = 250 pF, R <sub>L</sub> = 3 k $\Omega$ ,<br>V <sub>CC</sub> = 3 V, See <a href="#">Figure 1</a> One DIN switching,           | 1000 |                    |     |            |
| t <sub>sk(p)</sub> Pulse skew <sup>(3)</sup> | C <sub>L</sub> = 150 pF to 2500 pF, R <sub>L</sub> = 3 k $\Omega$ to 7 k $\Omega$ , See <a href="#">Figure 2</a>                             |      | 25                 |     | ns         |
| SR(tr) Slew rate,<br>transition region       | V <sub>CC</sub> = 3.3 V, R <sub>L</sub> = 3 k $\Omega$ to 7 k $\Omega$ ,<br>C <sub>L</sub> = 150 pF to 1000 pF, See <a href="#">Figure 1</a> | 24   |                    | 150 | V/ $\mu$ s |

(1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.

(2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(3) Pulse skew is defined as |t<sub>PLH</sub> – t<sub>PHL</sub>| of each channel of the same device.

## ESD Protection

| TERMINAL |     | TEST CONDITIONS                  | TYP      | UNIT |
|----------|-----|----------------------------------|----------|------|
| NAME     | NO. |                                  |          |      |
| DOUT     | 13  | Human-Body Model                 | $\pm 15$ | kV   |
|          |     | Contact Discharge (IEC61000-4-2) | $\pm 8$  |      |
|          |     | Air-Gap Discharge (IEC61000-4-2) | $\pm 8$  |      |

## RECEIVER SECTION

### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 3](#))

| PARAMETER        |                                                         | TEST CONDITIONS                | MIN                   | TYP <sup>(2)</sup>    | MAX | UNIT |
|------------------|---------------------------------------------------------|--------------------------------|-----------------------|-----------------------|-----|------|
| V <sub>OH</sub>  | High-level output voltage                               | I <sub>OH</sub> = –1 mA        | V <sub>CC</sub> – 0.6 | V <sub>CC</sub> – 0.1 |     | V    |
| V <sub>OL</sub>  | Low-level output voltage                                | I <sub>OL</sub> = 1.6 mA       |                       |                       | 0.4 | V    |
| V <sub>IT+</sub> | Positive-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V        |                       | 1.5                   | 2.4 | V    |
|                  |                                                         | V <sub>CC</sub> = 5 V          |                       | 1.8                   | 2.4 |      |
| V <sub>IT–</sub> | Negative-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V        | 0.6                   | 1.2                   |     | V    |
|                  |                                                         | V <sub>CC</sub> = 5 V          | 0.8                   | 1.5                   |     |      |
| V <sub>hys</sub> | Input hysteresis (V <sub>IT+</sub> – V <sub>IT–</sub> ) |                                |                       | 0.5                   |     | V    |
| I <sub>off</sub> | Output leakage current                                  |                                |                       | ±0.05                 | ±10 | μA   |
| r <sub>i</sub>   | Input resistance                                        | V <sub>I</sub> = ±3 V to ±25 V | 3                     | 5                     | 7   | kΩ   |

(1) Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

(2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER          |                                                   | TEST CONDITIONS                                       | TYP <sup>(2)</sup> | UNIT |
|--------------------|---------------------------------------------------|-------------------------------------------------------|--------------------|------|
| t <sub>PLH</sub>   | Propagation delay time, low- to high-level output | C <sub>L</sub> = 150 pF, See <a href="#">Figure 3</a> | 150                | ns   |
| t <sub>PHL</sub>   | Propagation delay time, high- to low-level output | C <sub>L</sub> = 150 pF, See <a href="#">Figure 3</a> | 150                | ns   |
| t <sub>sk(p)</sub> | Pulse skew <sup>(3)</sup>                         | See <a href="#">Figure 3</a>                          | 50                 | ns   |

(1) Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

(2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

(3) Pulse skew is defined as |t<sub>PLH</sub> – t<sub>PHL</sub>| of each channel of the same device.

## ESD Protection

| TERMINAL |     | TEST CONDITIONS                  | TYP | UNIT |
|----------|-----|----------------------------------|-----|------|
| NAME     | NO. |                                  |     |      |
| RIN      | 8   | Human-Body Model                 | ±15 | kV   |
|          |     | Contact Discharge (IEC61000-4-2) | ±8  |      |
|          |     | Air-Gap Discharge (IEC61000-4-2) | ±15 |      |

## AUTO-POWERDOWN SECTION

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 4](#))

| PARAMETER               |                                                                                    | TEST CONDITIONS                                                                  | MIN            | MAX | UNIT |
|-------------------------|------------------------------------------------------------------------------------|----------------------------------------------------------------------------------|----------------|-----|------|
| $V_{T+}(\text{valid})$  | Receiver input threshold for $\overline{\text{INVALID}}$ high-level output voltage | FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$                             |                | 2.7 | V    |
| $V_{T-}(\text{valid})$  | Receiver input threshold for $\overline{\text{INVALID}}$ high-level output voltage | FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$                             | –2.7           |     | V    |
| $V_{T(\text{invalid})}$ | Receiver input threshold for $\overline{\text{INVALID}}$ low-level output voltage  | FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$                             | –0.3           | 0.3 | V    |
| $V_{OH}$                | $\overline{\text{INVALID}}$ , READY output voltage high                            | $I_{OH} = -1 \text{ mA}$ , FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$  | $V_{CC} - 0.6$ |     | V    |
| $V_{OL}$                | $\overline{\text{INVALID}}$ , READY output voltage low                             | $I_{OL} = 1.6 \text{ mA}$ , FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$ |                | 0.4 | V    |

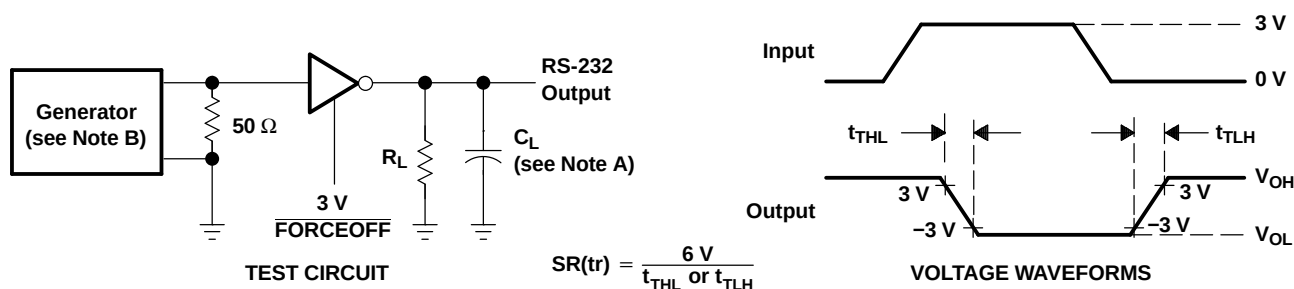
### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 4](#))

| PARAMETER      |                                                   | MIN                    | TYP <sup>(1)</sup> | MAX | UNIT          |
|----------------|---------------------------------------------------|------------------------|--------------------|-----|---------------|
| $t_{INVH}$     | Propagation delay time, low- to high-level output |                        | 1                  |     | $\mu\text{s}$ |
| $t_{INVL}$     | Propagation delay time, high- to low-level output |                        | 30                 |     | $\mu\text{s}$ |
| $t_{WU}$       | Supply enable time                                |                        | 100                |     | $\mu\text{s}$ |
| $t_{AUTOPRDN}$ | Driver or receiver edge to driver's shutdown      | $V_{CC} = 5 \text{ V}$ |                    | 15  | 30 60 s       |

(1) All typical values are at  $V_{CC} = 3.3 \text{ V}$  or  $V_{CC} = 5 \text{ V}$ , and  $T_A = 25^\circ\text{C}$ .

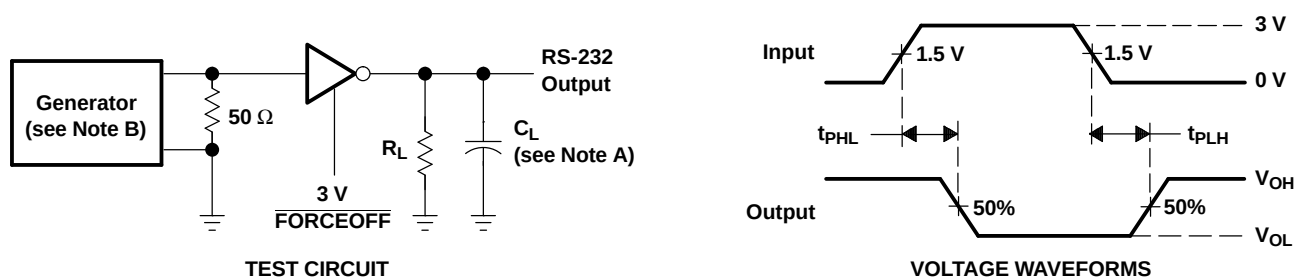
## PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

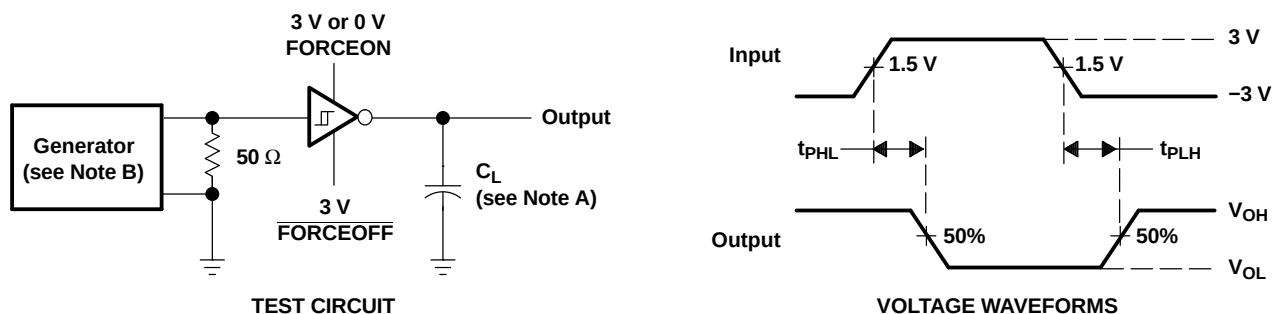
Figure 1. Driver Slew Rate



NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

Figure 2. Driver Pulse Skew



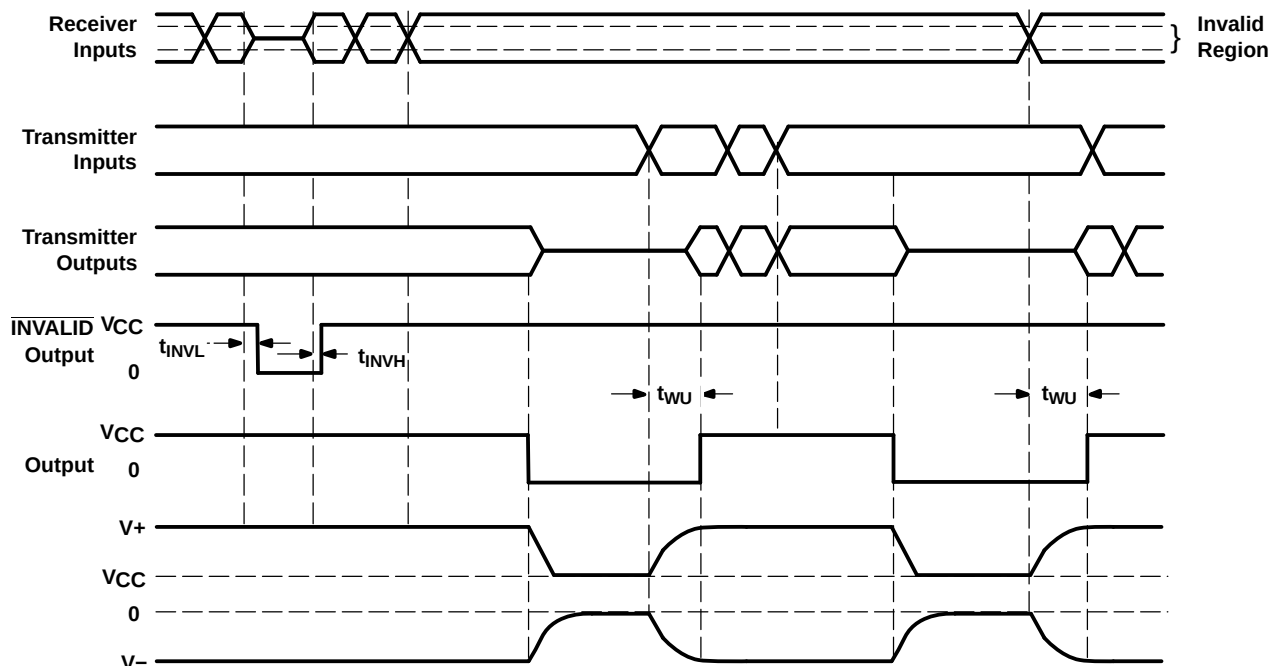
NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The pulse generator has the following characteristics:  $Z_O = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

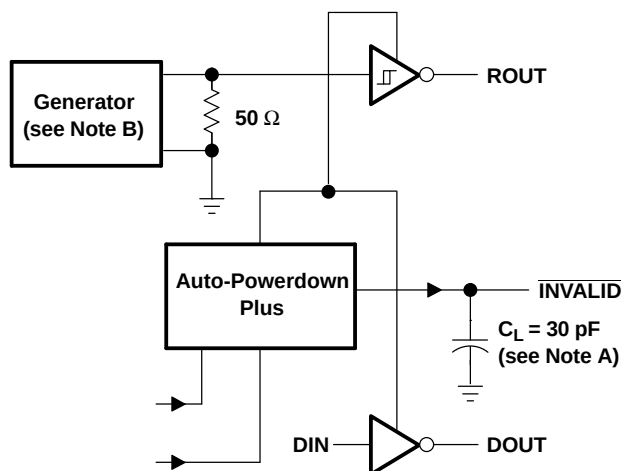
Figure 3. Receiver Propagation Delay Times



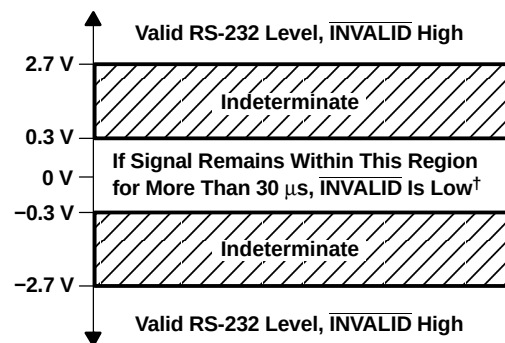
PARAMETER MEASUREMENT INFORMATION (continued)



VOLTAGE WAVEFORMS



TEST CIRCUIT



<sup>†</sup> Auto-powerdown disables drivers and reduces supply current to 1  $\mu$ A.

Figure 4.  $\overline{\text{INVALID}}$  Propagation Delay Times and Driver Enabling Time

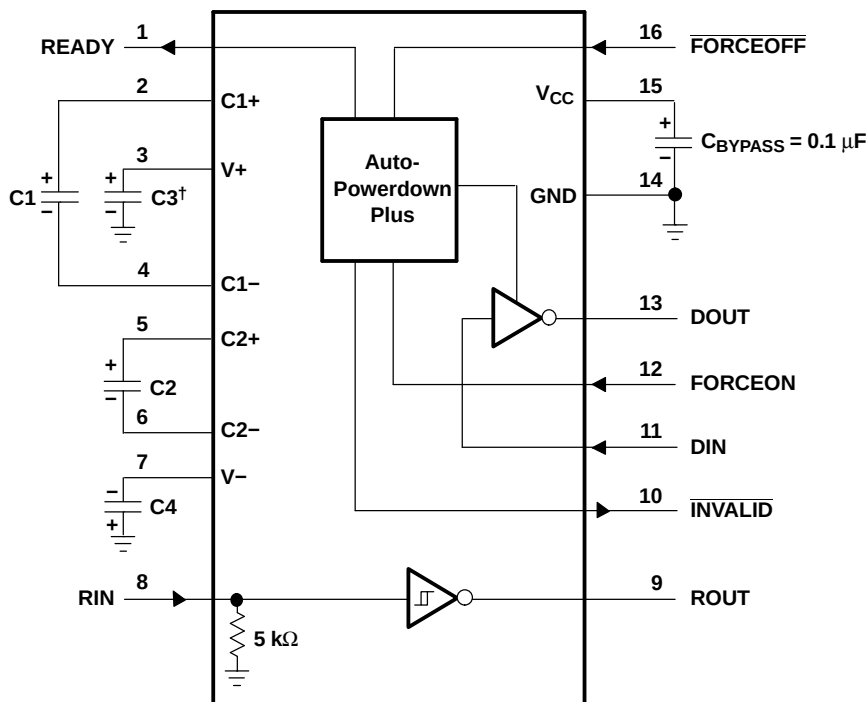
# MAX3227

## 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER

### WITH $\pm 15$ -kV ESD PROTECTION

SLLS673A – AUGUST 2005 – REVISED FEBRUARY 2006

#### APPLICATION INFORMATION



† C3 can be connected to  $V_{CC}$  or GND.

NOTES: A. Resistor values shown are nominal.

B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

$V_{CC}$  vs CAPACITOR VALUES

| $V_{CC}$          | C1            | C2, C3, and C4 |
|-------------------|---------------|----------------|
| 3.3 V $\pm$ 0.3 V | 0.1 $\mu$ F   | 0.1 $\mu$ F    |
| 5 V $\pm$ 0.5 V   | 0.047 $\mu$ F | 0.33 $\mu$ F   |
| 3 V to 5.5 V      | 0.1 $\mu$ F   | 0.47 $\mu$ F   |

Figure 5. Typical Operating Circuit and Capacitor Values

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| MAX3227CDB       | ACTIVE        | SSOP         | DB                 | 16   | 80             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MP227C                  | <a href="#">Samples</a> |
| MAX3227CDBG4     | ACTIVE        | SSOP         | DB                 | 16   | 80             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MP227C                  | <a href="#">Samples</a> |
| MAX3227CDBR      | ACTIVE        | SSOP         | DB                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | MP227C                  | <a href="#">Samples</a> |
| MAX3227IDB       | ACTIVE        | SSOP         | DB                 | 16   | 80             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | MP227I                  | <a href="#">Samples</a> |
| MAX3227IDBR      | ACTIVE        | SSOP         | DB                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | MP227I                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

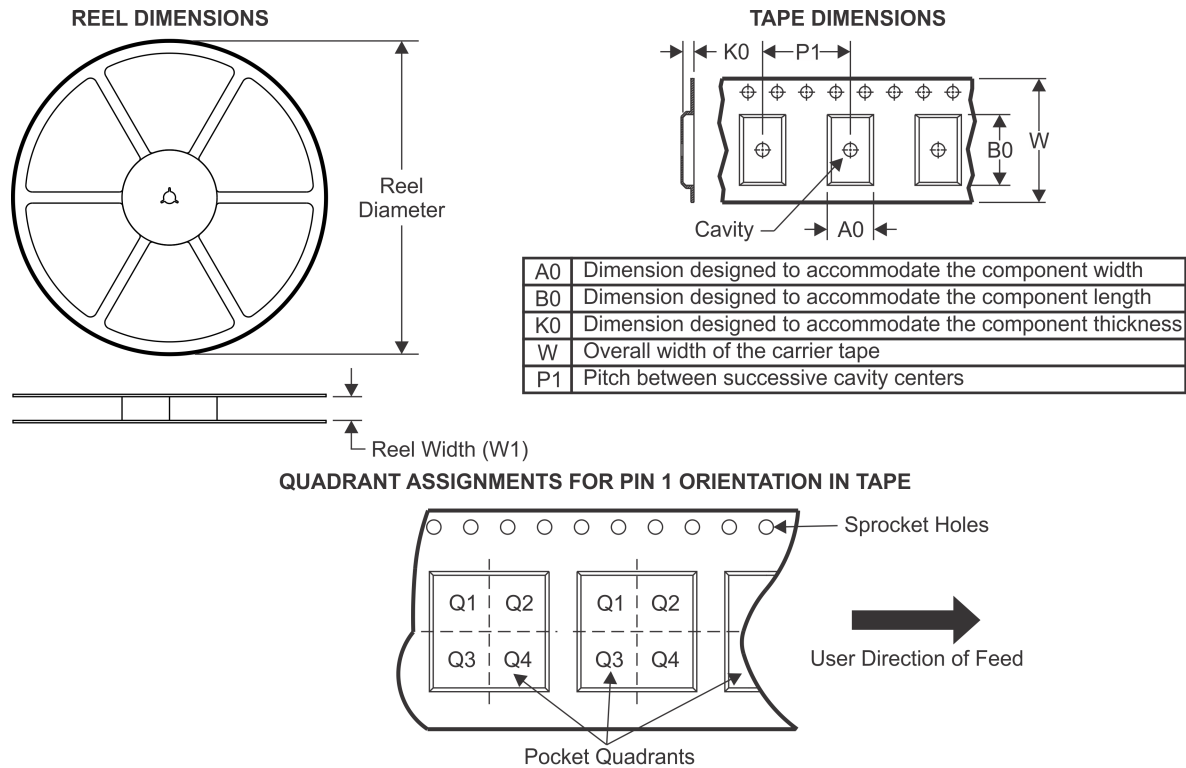
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

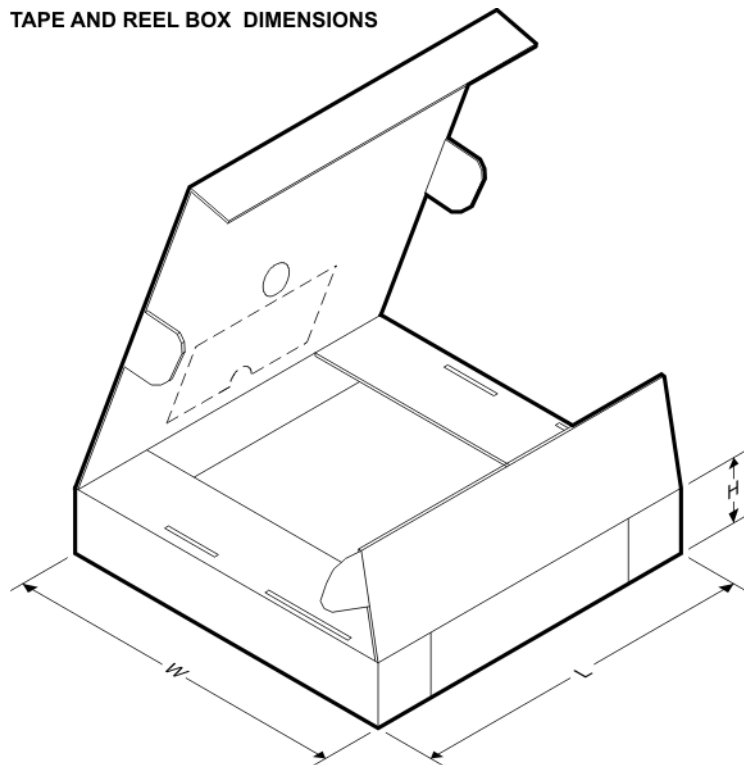
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MAX3227CDBR | SSOP         | DB              | 16   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| MAX3227IDBR | SSOP         | DB              | 16   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |

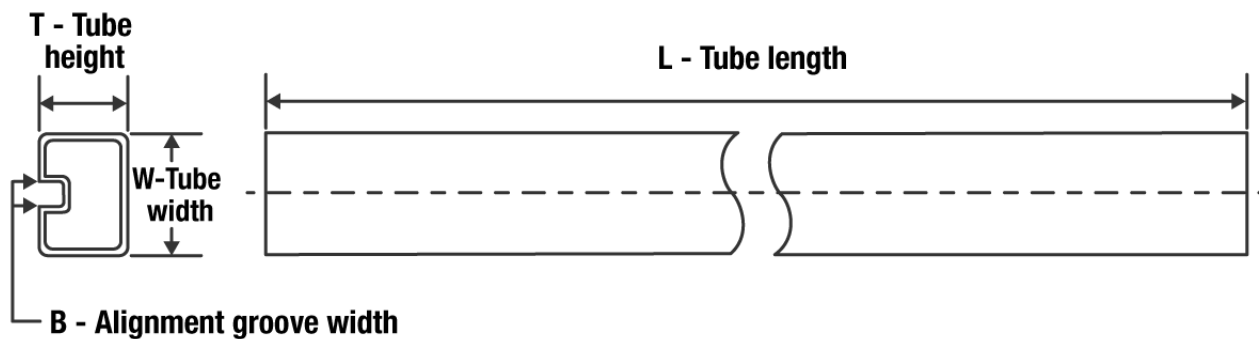
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MAX3227CDBR | SSOP         | DB              | 16   | 2000 | 853.0       | 449.0      | 35.0        |
| MAX3227IDBR | SSOP         | DB              | 16   | 2000 | 853.0       | 449.0      | 35.0        |

## TUBE



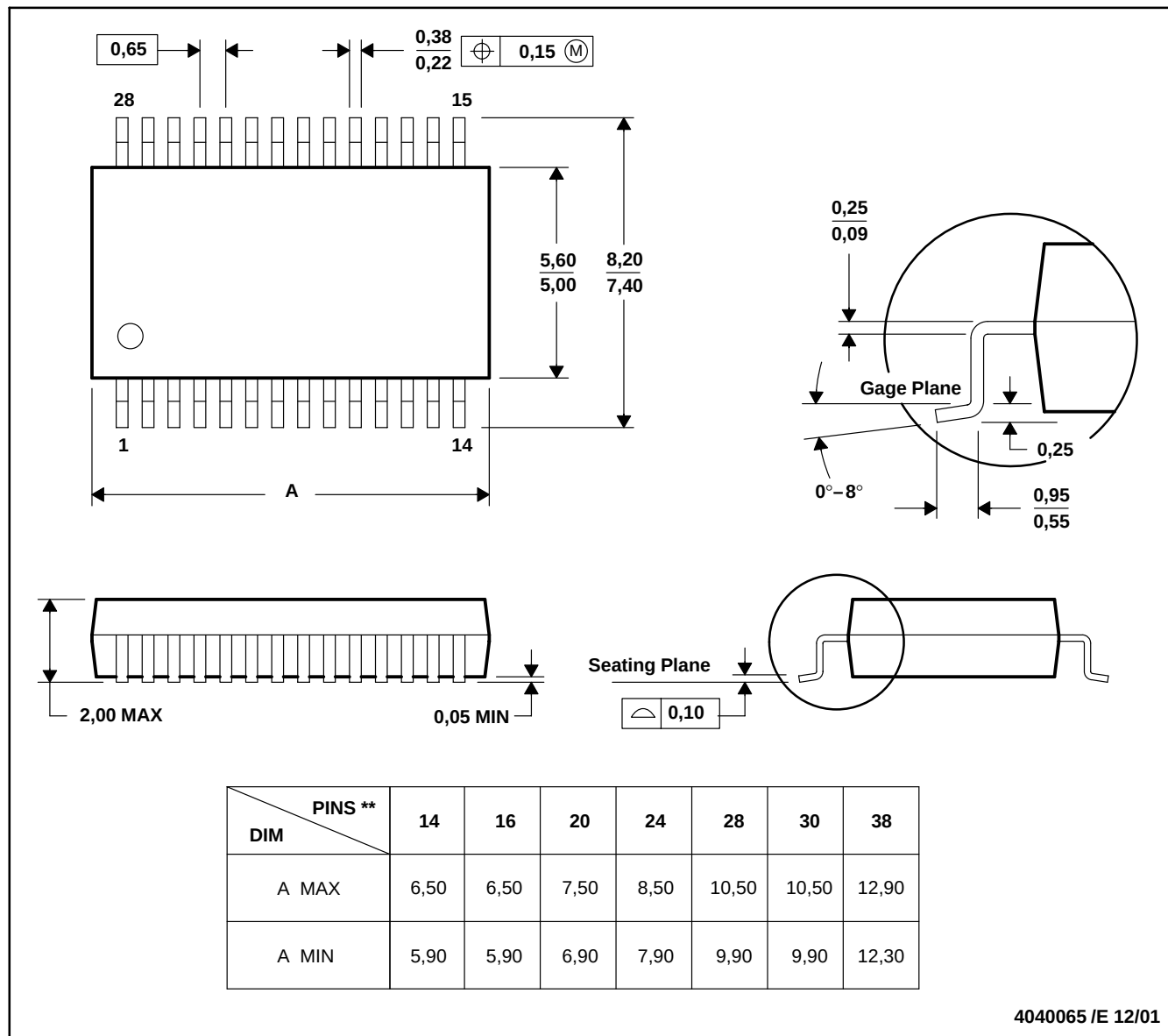
\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| MAX3227CDB   | DB           | SSOP         | 16   | 80  | 530    | 10.5   | 4000   | 4.1    |
| MAX3227CDBG4 | DB           | SSOP         | 16   | 80  | 530    | 10.5   | 4000   | 4.1    |
| MAX3227IDB   | DB           | SSOP         | 16   | 80  | 530    | 10.5   | 4000   | 4.1    |

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150



## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2022, Texas Instruments Incorporated